36V, 2µA I_Q, 200mA Low Dropout Voltage Linear Regulator

General Description

The RT9069 is a low-dropout (LDO) voltage regulators with enable function offering the benefits of high input voltage, low-dropout voltage, low-power consumption, and miniaturized packaging.

The features of low quiescent current as low as 2μ A and zero disable current is ideal for powering the battery equipment to a longer service life. The RT9069 is stable with the ceramic output capacitor over its wide input range from 3.5V to 36V and the entire range of output load current (0mA to 200mA).

Applications

- Portable, Battery Powered Equipments
- Extra Low Voltage Microcontrollers
- Notebook Computers

Marking Information

For marking information, contact our sales representative directly or through a Richtek distributor located in your area.

Note :

Richtek products are :

- ► RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- ► Suitable for use in SnPb or Pb-free soldering processes.

Simplified Application Circuit



Features

- 2µA Ground Current at no Load
- ±2% Output Accuracy
- 200mA Output Current with EN
- Zero Disable Current
- Maximum Operating Input Voltage 36V
- Dropout Voltage: 0.2V at 10mA/ VIN 5V
- Support Fixed Output Voltage 2.5V, 3V, 3.3V, 5V, 9V, 12V
- Stable with Ceramic or Tantalum Capacitor
- Current Limit Protection
- Over-Temperature Protection
- RoHS Compliant and Halogen Free

Ordering Information



Pin Configurations

(TOP VIEW)



Functional Pin Description

	Pin	No.			
SOP-8 (Exposed Pad)	SOT-23-5	SOT-89-5	UDFN-6L 1.6x1.6	Pin Name	Pin Function
1	1	5	1	VCC	Supply Voltage Input.
2, 4, 5, 6	3	4	2, 5	NC	No Internal Connection.
3	5	1	3	VOUT	Output of the Regulator.
7, 9 (Exposed Pad)	2	2	6, 7 (Exposed Pad)	GND	Ground. The exposed pad must be soldered to a large PCB and connected to GND for maximum thermal dissipation.
8	4	3	4	EN	Enable Control Input.

Function Block Diagram



Operation

Basic Operation

The RT9069 is a high input voltage linear regulator designed especially for low external component systems. The input voltage range is from 3.5V to 36V. The minimum required output capacitance for stable operation is 1μ F effective capacitance after consideration of the temperature and voltage coefficient of the capacitor.

Output Transistor

The RT9069 builds in a P-MOSFET output transistor which provides a low switch-on resistance for low dropout voltage applications.

Error Amplifier

The Error Amplifier compares the internal reference voltage with the output feedback voltage from the internal divider, and controls the Gate voltage of P-MOSFET to support good line regulation and load regulation at output voltage.

Enable

The RT9069 delivers the output power when it is set to enable state. When it works in disable state, there is no output power and the operation quiescent current is zero.

Current Limit Protection

The RT9069 provides current limit function to prevent the device from damages during over-load or shorted-circuit conditions. This current is detected by an internal sensing transistor.

Over-Temperature Protection

The over-temperature protection function turns off the P-MOSFET when the junction temperature exceeds 150°C (typ.) and the output current exceeds 4mA. Once the junction temperature cools down by approximately 20°C, the regulator automatically resumes operation.

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Absolute Maximum Ratings (Note 1)	
• VCC, EN to GND	-0.3V to 40V
VOUT to VCC	-40V to 0.3V
VOUT to GND	
RT9069-90/RT9069-C0	–0.3V to 15V
RT9069-25/RT9069-30/RT9069-33/RT9069-50	–0.3V to 6V
• Power Dissipation, $P_D @ T_A = 25^{\circ}C$	
SOP-8 (Exposed Pad)	3.26W
SOT-23-5	0.45W
SOT-89-5	0.87W
UDFN-6L 1.6x1.6	2.15W
Package Thermal Resistance (Note 2)	
SOP-8 (Exposed Pad), θ_{JA}	30.6°C/W
SOP-8 (Exposed Pad), θ_{JC}	3.4°C/W
SOT-23-5, θJA	218.1°C/W
SOT-23-5, θJC	28.5°C/W
SOT-89-5, θJA	113.9°C/W
SOT-89-5, θJC	6.9°C/W
UDFN-6L 1.6x1.6, θJA	46.5°C/W
UDFN-6L 1.6x1.6, θJC	18.6°C/W
Lead Temperature (Soldering, 10 sec.)	260°C
• Junction Temperature	150°C
Storage Temperature Range	–65°C to 150°C
ESD Susceptibility (Note 3)	
HBM (Human Body Model)	2kV
Recommended Operating Conditions (Note 4)	

Recommended Operating Conditions (Note 4)

•	Supply Input Voltage	-3.5V to 36V
•	Junction Temperature Range	40°C to 125°C
•	Ambient Temperature Range	40°C to 85°C

Electrical Characteristics

(V_{CC} = 5V, C_{IN} = 1 μ F, T_A = 25°C, for each LDO unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Supply Voltage	Vcc		3.5		36	V
Output Voltage Range	Vout		2.5		12	V
DC Output Accuracy	ΔVουτ	I _{LOAD} = 10mA	-2		+2	%
Dropout Voltage	Vdrop	I _{LOAD} = 10mA, V _{CC} > 5V		0.2	0.36	V

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Parameter		Symbol	Test Conditions	Min	Тур	Max	Unit	
V _{CC} Consumption Current			I_{LOAD} = 0mA, $V_{OUT} \le 5.5V$	-	2	3.5	μA	
		lq	$I_{LOAD} = 0mA, V_{OUT} > 5.5V,$		3.5	5	μA	
			V _{CC} =15V					
Shutdown Current			$V_{EN} = 0V$		0.1		μA	
Shutdown Leakage	Current		$V_{EN} = 0V, V_{OUT} = 0V$		0.1		μA	
EN Input Current		I _{EN}	V _{EN} = 36V		0.1		μA	
			ILOAD = 1mA, VOUT +1 < VCC < 36V, VOUT > 3.3V		0.04	0.5	0/	
Line Regulation		ΔV_{LINE}	$\label{eq:loss} \begin{array}{l} I_{LOAD} = 1 m A, \\ V_{OUT} + 1 < V_{CC} < 36 V, \ V_{OUT} \leq 3.3 V \end{array}$	-			%	
Load Regulation		ΔV_{LOAD}	0mA < I _{LOAD} < 100mA	-1		1	%	
Output Current Limi	t	I _{LIM}	V _{OUT} = 0.5 x V _{OUT(normal)}	200	350		mA	
Enable Input Logic-High		VIH				2	V	
Voltage	Logic-Low	VIL		0.6				
Thermal Shutdown Temperature		T _{SD}	I _{LOAD} = 30mA		150		°C	
Thermal Shutdown	Hysteresis	ΔT_{SD}			20		°C	

- **Note 1.** Stresses beyond those listed "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions may affect device reliability.
- Note 2. θ_{JA} is measured at $T_A = 25^{\circ}C$ on a high effective thermal conductivity four-layer test board per JEDEC 51-7. θ_{JC} is measured at the exposed pad of the package.
- Note 3. Devices are ESD sensitive. Handling precaution is recommended.
- Note 4. The device is not guaranteed to function outside its operating conditions.



Typical Application Circuit



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Typical Operating Characteristics









Quiescent Current vs. Supply Voltage 2 Ouiescent Current (µA) 1.8 1.7 1.6 $V_{OUT} = 2.5V$ 1.5 3 6 9 12 15 18 21 24 27 30 33 36 Supply Voltage (V)



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Enable Threshold vs. Temperature 2 1.5 **High Threshold** EN Voltage (V) 1 Low Threshold 0.5 Vcc = 36V0 75 -50 -25 0 25 50 100 125 Temperature (°C)







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RT9069



RT9069

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Time (100µs/Div)



Time (25µs/Div)



Time (25µs/Div)

Application Information

Thermal Considerations

For continuous operation, do not exceed absolute maximum junction temperature. The maximum power dissipation depends on the thermal resistance of the IC package, PCB layout, rate of surrounding airflow, and difference between junction and ambient temperature. The maximum power dissipation can be calculated by the following formula :

$\mathsf{P}_{\mathsf{D}(\mathsf{MAX})} = (\mathsf{T}_{\mathsf{J}(\mathsf{MAX})} - \mathsf{T}_{\mathsf{A}}) / \theta_{\mathsf{J}\mathsf{A}}$

where $T_{J(MAX)}$ is the maximum junction temperature, T_A is the ambient temperature, and θ_{JA} is the junction to ambient thermal resistance.

For recommended operating condition specifications, the maximum junction temperature is 125°C. The junction to ambient thermal resistance, θ_{JA} , is layout dependent. For SOP-8 (Exposed Pad) packages, the thermal resistance, θ_{JA} , is 30.6°C/W on a standard JEDEC 51-7 four-layer thermal test board. For SOT-23-5 package, the thermal resistance, θ_{JA} , is 218.1°C/W on a standard JEDEC 51-7 four-layer thermal test board. For SOT-89-5 package, the thermal resistance, θ_{JA} , is 113.9°C/W on a standard JEDEC 51-7 four-layer thermal test board. For UDFN-6L 1.6x1.6 package, the thermal resistance, θ_{JA} , is 46.5°C/W on a standard JEDEC 51-7 four-layer thermal test board. The maximum power dissipation at T_A = 25°C can be calculated by the following formula :

 $P_{D(MAX)} = (125^{\circ}C - 25^{\circ}C) / (30.6^{\circ}C/W) = 3.2679W$ for SOT-8 (Exposed Pad) package

 $P_{D(MAX)} = (125^{\circ}C - 25^{\circ}C) / (218.1^{\circ}C/W) = 0.4585W$ for SOT-23-5 package

 $P_{D(MAX)} = (125^{\circ}C - 25^{\circ}C) / (113.9^{\circ}C/W) = 0.8779W \text{ for }$ SOT-89-5 package

 $P_{D(MAX)} = (125^{\circ}C - 25^{\circ}C) / (46.5^{\circ}C/W) = 2.15W$ for UDFN-6L 1.6x1.6 package

The maximum power dissipation depends on the operating ambient temperature for fixed $T_{J(MAX)}$ and thermal resistance, θ_{JA} . The derating curve in Figure 1 allows the designer to see the effect of rising ambient temperature on the maximum power dissipation



Figure 1. Derating Curve of Maximum Power Dissipation



Outline Dimension



Symbol		Dimensions	n Millimeters	Dimensions In Inches		
		Min	Max	Min	Мах	
А		4.801	5.004	0.189	0.197	
В		3.810	4.000	0.150	0.157	
С		1.346	1.753	0.053	0.069	
D		0.330	0.510	0.013	0.020	
F		1.194	1.346	0.047	0.053	
н		0.170	0.254	0.007	0.010	
I		0.000	0.152	0.000	0.006	
J		5.791	6.200	0.228	0.244	
М		0.406	1.270	0.016	0.050	
Option 1	Х	2.000	2.300	0.079	0.091	
Option 1	Y	2.000	2.300	0.079	0.091	
Option 2	Х	2.100	2.500	0.083	0.098	
Option 2	Y	3.000	3.500	0.118	0.138	

8-Lead SOP (Exposed Pad) Plastic Package

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Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
	Min	Max	Min	Max	
А	0.889	1.295	0.035	0.051	
A1	0.000	0.152	0.000	0.006	
В	1.397	1.803	0.055	0.071	
b	0.356	0.559	0.014	0.022	
С	2.591	2.997	0.102	0.118	
D	2.692	3.099	0.106	0.122	
е	0.838	1.041	0.033	0.041	
Н	0.080	0.254	0.003	0.010	
L	0.300	0.610	0.012	0.024	

SOT-23-5 Surface Mount Package

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Symbol	Dimensions	n Millimeters	Dimensions In Inches		
	Min	Max	Min	Max	
А	1.400	1.600	0.055	0.063	
b	0.360	0.508	0.014	0.020	
В	2.400	2.600	0.094	0.102	
b1	0.406	0.533	0.016	0.021	
С	3.937	4.250	0.155	0.167	
C1	0.800	1.194	0.031	0.047	
D	4.400	4.600	0.173	0.181	
D1	1.397	1.700	0.055	0.067	
е	1.400	1.600	0.055	0.063	
Н	0.356	0.430	0.014	0.017	

5-Lead SOT-89 Surface Mount Package



Note : The configuration of the Pin #1 identifier is optional, but must be located within the zone indicated.

Symbol	Dimensions	n Millimeters	Dimension	s In Inches
	Min.	Max.	Min.	Max.
А	0.500	0.600	0.020	0.024
A1	0.000	0.050	0.000	0.002
A3	0.100	0.175	0.004	0.007
b	0.200	0.300	0.008	0.012
D	1.500	1.700	0.059	0.067
D2	0.950	1.050	0.037	0.041
E	1.500	1.700	0.059	0.067
E2	0.550	0.650	0.022	0.026
е	0.500		0.020	
L	0.200	0.300	0.008	0.012

U-Type 6L DFN 1.6x1.6 Package

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